

N-channel 40 V, 2.8 mΩ logic level MOSFET in LFPAK56 31 May 2018

Product data sheet

1. General description

Automotive qualified N-channel MOSFET using the latest Trench 9 low ohmic superjunction technology, housed in a robust LFPAK56 package. This product has been fully designed and qualified to meet AEC-Q101 requirements delivering high performance and endurance.

2. Features and benefits

- Fully automotive qualified to AEC-Q101:
 - 175 °C rating suitable for thermally demanding environments
- Trench 9 Superjunction technology:
 - Reduced cell pitch enables enhanced power density and efficiency with lower R_{DSon} in • same footprint
 - Improved SOA and avalanche capability compared to standard TrenchMOS •
 - Tight V_{GS(th)} limits enable easy paralleling of MOSFETs
- LFPAK Gull Wing leads:
 - · High Board Level Reliability absorbing mechanical stress during thermal cycling, unlike traditional QFN packages
 - Visual (AOI) soldering inspection, no need for expensive x-ray equipment
 - Easy solder wetting for good mechanical solder joint
- LFPAK copper clip technology:
 - Improved reliability, with reduced Rth and RDSon
 - Increases maximum current capability and improved current spreading •

3. Applications

- 12 V automotive systems
- Motors, lamps and solenoid control
- Start-Stop micro-hybrid applications
- Transmission control
- Ultra high performance power switching

4. Quick reference data

| Symbol | Parameter | Conditions | | Min | Тур | Мах | Unit |
|------------------|-------------------------|---|-----|-----|-----|-----|------|
| V _{DS} | drain-source voltage | 25 °C ≤ T _j ≤ 175 °C | | - | - | 40 | V |
| I _D | drain current | V _{GS} = 10 V; T _{mb} = 25 °C | [1] | - | - | 120 | А |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; <u>Fig. 1</u> | | - | - | 172 | W |

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| Symbol | Parameter | Conditions | | Min | Тур | Max | Unit | |
|-------------------|----------------------------------|---|--|------|------|-----|------|--|
| Static charact | Static characteristics | | | | | | | |
| R _{DSon} | drain-source on-state resistance | V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 10 | | 1.68 | 2.4 | 2.8 | mΩ | |
| Dynamic char | acteristics | | | | | | | |
| Q _{GD} | gate-drain charge | I_D = 25 A; V_{DS} = 20 V; V_{GS} = 4.5 V; Fig. 12; Fig. 13 | | - | 4.7 | 9 | nC | |
| Source-drain | diode | | | | | | | |
| Q _r | recovered charge | $ I_{S} = 25 \text{ A}; \text{ d}I_{S}/\text{d}t = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 ^{\circ}\text{C} $ | | - | 20.4 | - | nC | |
| S | softness factor | $ I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 ^{\circ}\text{C}; \text{ Fig. 16} $ | | - | 0.83 | - | | |

[1] 120A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

5. Pinning information

| | Pinning inf | | | |
|-----|-------------|-----------------------------------|--|----------------|
| Pin | Symbol | Description | Simplified outline | Graphic symbol |
| 1 | S | source | mb | D |
| 2 | S | source | ل ا دے ب ا ر | |
| 3 | S | source | | G C F A |
| 4 | G | gate | | mbb076 S |
| mb | D | mounting base; connected to drain | 1 2 3 4 LFPAK56; Power- SO8 (SOT669) | |

6. Ordering information

| Table 3. Ordering information | | | | | |
|-------------------------------|-----------------------|--|---------|--|--|
| Type number | Package | | | | |
| | Name | Description | Version | | |
| BUK9Y2R8-40H | LFPAK56; Power-SO8 | plastic, single-ended surface-mounted package; 4 terminals | SOT669 | | |

7. Marking

| Table | 4. | Marking | codes |
|-------|----|---------|-------|
| | | | |

| Type number | Marking code |
|--------------|--------------|
| BUK9Y2R8-40H | 92H840 |

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8. Limiting values

Table 5. Limiting values

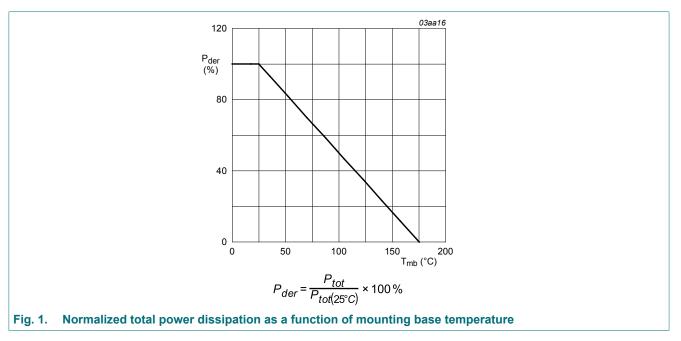
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | | Min | Мах | Unit |
|----------------------|---|---|---------|-----|-----|------|
| V _{DS} | drain-source voltage | 25 °C ≤ T _j ≤ 175 °C | | - | 40 | V |
| V _{GS} | gate-source voltage | DC; T _j ≤ 175 °C | | -10 | 16 | V |
| P _{tot} | total power dissipation | T _{mb} = 25 °C; <u>Fig. 1</u> | | - | 172 | W |
| ID | drain current | V _{GS} = 10 V; T _{mb} = 25 °C | [1] | - | 120 | А |
| I _{DM} | peak drain current | pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$; Fig. 2 | | - | 600 | А |
| T _{stg} | storage temperature | | | -55 | 175 | °C |
| Tj | junction temperature | | | -55 | 175 | °C |
| Source-drai | n diode | | | | | |
| I _S | source current | T _{mb} = 25 °C | | - | 120 | А |
| I _{SM} | peak source current | pulsed; $t_p \le 10 \ \mu s$; $T_{mb} = 25 \ ^{\circ}C$ | | - | 600 | А |
| Avalanche r | uggedness | | | • | | |
| E _{DS(AL)S} | non-repetitive drain- source avalanche energy | I_D = 120 A; $V_{sup} \le 40$ V; R_{GS} = 50 Ω; V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; unclamped; Fig. 3 | [2] [3] | - | 50 | mJ |

[1] 120A continuous current has been successfully demonstrated during application tests. Practically the current will be limited by PCB, thermal design and operating temperature.

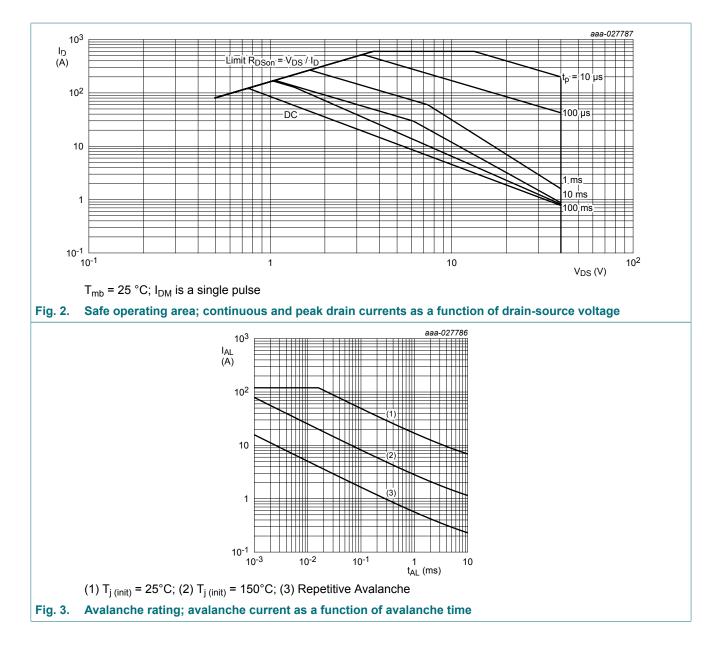
[2] Single-pulse avalanche rating limited by maximum junction temperature of 175 °C.

[3] Refer to application note AN10273 for further information.



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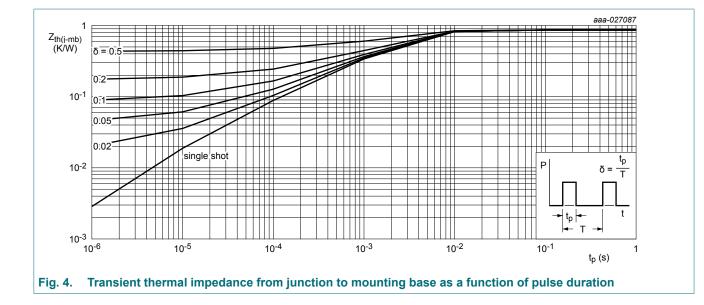


9. Thermal characteristics

Table 6. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Мах | Unit |
|-----------------------|---|---------------|-----|------|------|------|
| R _{th(j-mb)} | thermal resistance from junction to mounting base | <u>Fig. 4</u> | - | 0.77 | 0.87 | K/W |

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10. Characteristics

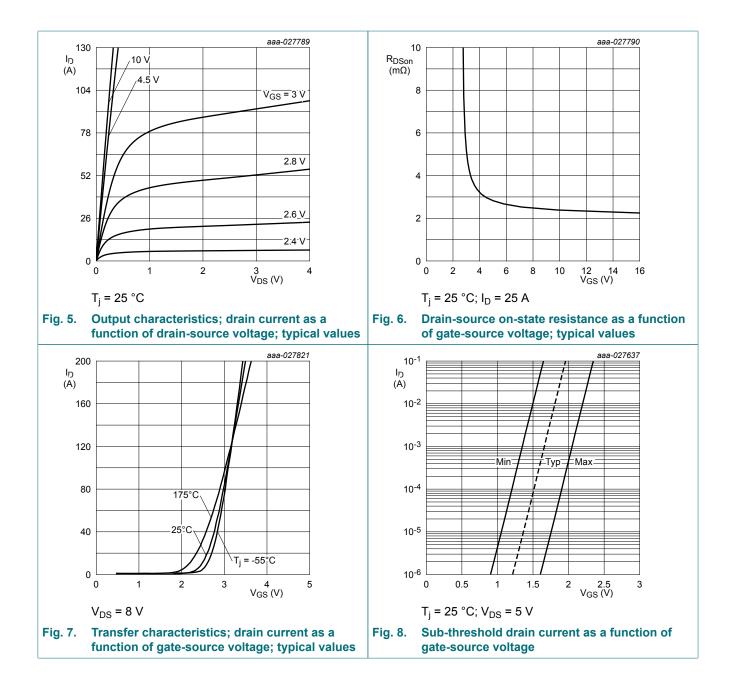
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| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|----------------------|-------------------------------|--|------|------|------|------|
| Static chara | octeristics | | | | | |
| V _{(BR)DSS} | drain-source | I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C | 40 | 43 | - | V |
| | breakdown voltage | I _D = 250 μA; V _{GS} = 0 V; T _j = -40 °C | - | 40.5 | - | V |
| | | I _D = 250 μA; V _{GS} = 0 V; T _j = -55 °C | 36 | 40 | - | V |
| V _{GS(th)} | gate-source threshold voltage | $I_D = 1 \text{ mA}; V_{DS} = V_{GS}; T_j = 25 \text{ °C}; Fig. 8;$ Fig. 9 | 1.35 | 1.66 | 2.05 | V |
| | | I _D = 1 mA; V _{DS} =V _{GS} ; T _j = 175 °C; <u>Fig. 9</u> | 0.6 | - | - | V |
| | | I _D = 1 mA; V _{DS} =V _{GS} ; T _j = -55 °C; <u>Fig. 9</u> | - | - | 2.5 | V |
| I _{DSS} | drain leakage current | V _{DS} = 40 V; V _{GS} = 0 V; T _j = 25 °C | - | 0.06 | 5 | μA |
| | | V _{DS} = 16 V; V _{GS} = 0 V; T _j = 125 °C | - | 0.8 | 10 | μA |
| | | V _{DS} = 40 V; V _{GS} = 0 V; T _j = 175 °C | - | 108 | 500 | μA |
| I _{GSS} | gate leakage current | V _{GS} = 16 V; V _{DS} = 0 V; T _j = 25 °C | - | 2 | 100 | nA |
| | | V _{GS} = -10 V; V _{DS} = 0 V; T _i = 25 °C | - | 2 | 100 | nA |

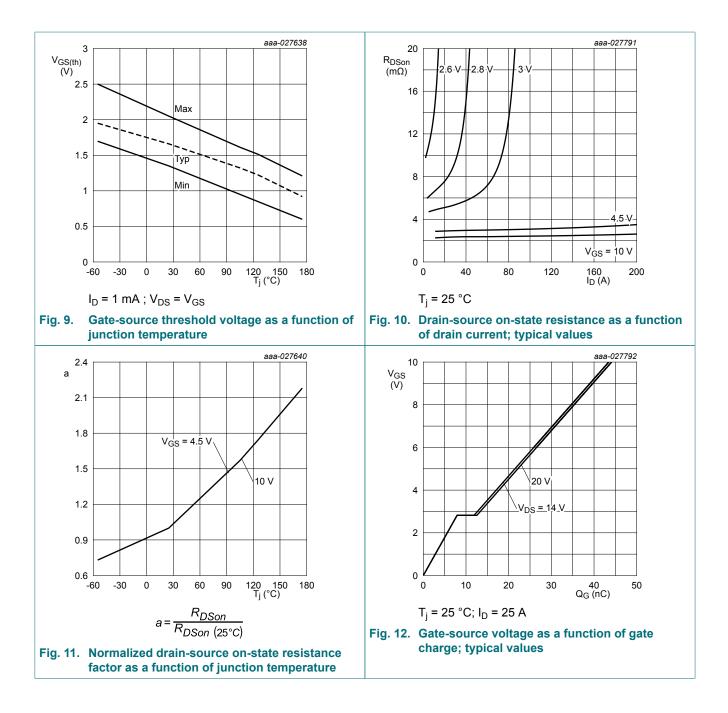
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| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|---------------------------------------|---|------|------|------|------|
| R _{DSon} | drain-source on-state resistance | V _{GS} = 10 V; I _D = 25 A; T _j = 25 °C; Fig. 10 | 1.68 | 2.4 | 2.8 | mΩ |
| | | V _{GS} = 10 V; I _D = 25 A; T _j = 105 °C; Fig. 11 | 2.5 | 3.6 | 4.4 | mΩ |
| | | V _{GS} = 10 V; I _D = 25 A; T _j = 125 °C; <u>Fig. 11</u> | 2.7 | 4 | 5 | mΩ |
| | | V _{GS} = 10 V; I _D = 25 A; T _j = 175 °C; <u>Fig. 11</u> | 3.5 | 4.9 | 6.2 | mΩ |
| | | V _{GS} = 4.5 V; I _D = 25 A; T _j = 25 °C; Fig. 10 | 2.1 | 3 | 3.9 | mΩ |
| | | V _{GS} = 4.5 V; I _D = 25 A; T _j = 105 °C; Fig. 11 | 3.1 | 4.5 | 6.1 | mΩ |
| | | V _{GS} = 4.5 V; I _D = 25 A; T _j = 125 °C; Fig. 11 | 3.4 | 4.9 | 6.8 | mΩ |
| | | V _{GS} = 4.5 V; I _D = 25 A; T _j = 175 °C; Fig. 11 | 4.4 | 6 | 8.6 | mΩ |
| R _G | gate resistance | f = 1 MHz; T _j = 25 °C | 0.32 | 0.8 | 2 | Ω |
| Dynamic cl | haracteristics | · · | 1 | | | |
| Q _{G(tot)} | e _{G(tot)} total gate charge | $I_{D} = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 10 \text{ V};$ Fig. 12; Fig. 13 | - | 44 | 62 | nC |
| | | $I_D = 25 \text{ A}; V_{DS} = 20 \text{ V}; V_{GS} = 4.5 \text{ V};$ Fig. 12; Fig. 13 | - | 20 | 28 | nC |
| Q _{GS} | gate-source charge | | - | 8 | 12.2 | nC |
| Q _{GD} | gate-drain charge | | - | 4.7 | 9 | nC |
| C _{iss} | input capacitance | V _{DS} = 25 V; V _{GS} = 0 V; f = 1 MHz; | - | 3101 | 4341 | pF |
| C _{oss} | output capacitance | T _j = 25 °C; <u>Fig. 14</u> | - | 709 | 992 | pF |
| C _{rss} | reverse transfer capacitance | | - | 112 | 246 | pF |
| t _{d(on)} | turn-on delay time | V_{DS} = 20 V; R _L = 0.8 Ω; V _{GS} = 4.5 V; | - | 18.9 | - | ns |
| t _r | rise time | $R_{G(ext)} = 5 \Omega$ | - | 21.6 | - | ns |
| t _{d(off)} | turn-off delay time |] [| - | 22.5 | - | ns |
| t _f | fall time |] [| - | 13.2 | - | ns |
| Source-dra | in diode | · · · | | - | | |
| V _{SD} | source-drain voltage | I _S = 25 A; V _{GS} = 0 V; T _j = 25 °C; <u>Fig. 15</u> | - | 0.81 | 1.2 | V |
| t _{rr} | reverse recovery time | $I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 \text{ °C}; \frac{\text{Fig. 16}}{2}$ | - | 28.1 | - | ns |
| Qr | recovered charge | $ I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ V_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 ^{\circ}\text{C} $ | - | 20.4 | - | nC |
| S | softness factor | $ I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -100 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ V_{DS} = 20 \text{ V}; \text{ T}_{j} = 25 \text{ °C}; \frac{\text{Fig. 16}}{2} $ | - | 0.83 | - | |
| | | $I_{S} = 25 \text{ A}; \text{ dI}_{S}/\text{dt} = -500 \text{ A}/\mu\text{s}; \text{ V}_{GS} = 0 \text{ V}; \\ \text{V}_{DS} = 20 \text{ V}; \text{ T}_{i} = 25 \text{ °C}; \frac{\text{Fig. 16}}{16}$ | - | 0.66 | - | |

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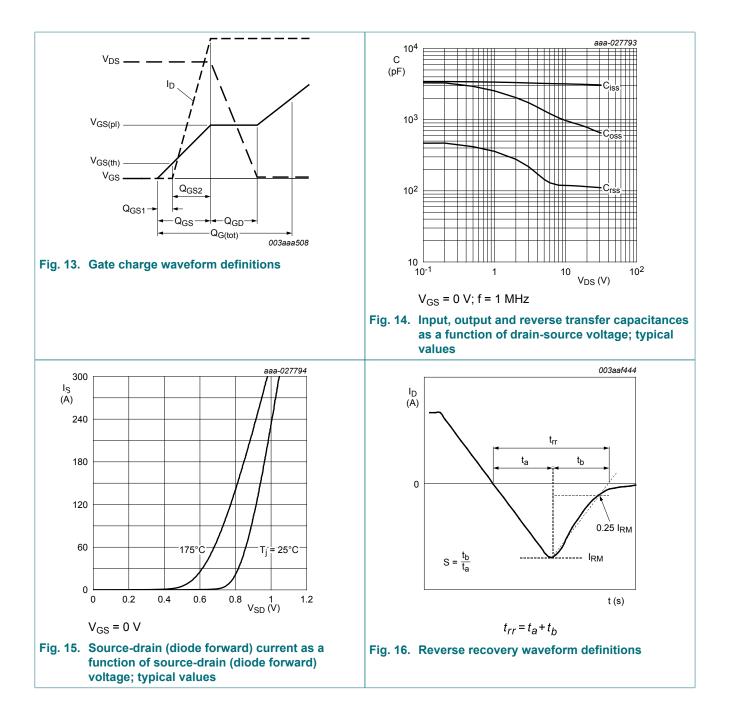


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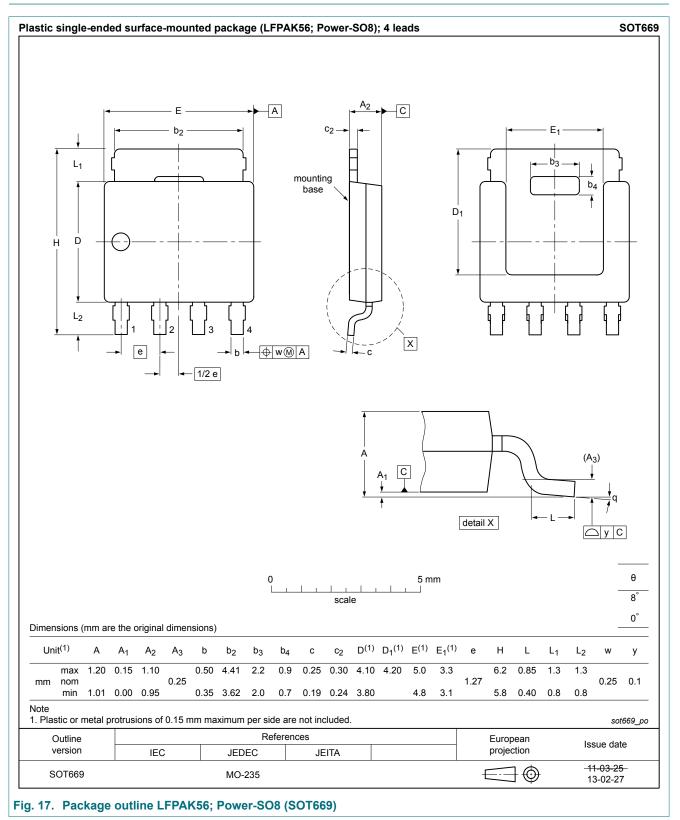
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N-channel 40 V, 2.8 mΩ logic level MOSFET in LFPAK56

11. Package outline



BUK9Y2R8-40H

N-channel 40 V, 2.8 m Ω logic level MOSFET in LFPAK56

12. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|-----------------------------------|-----------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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